



MAS-FIN-128

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By: [Signature]

Date: June 12, 2003 #11/

2831 \$
A
D. EVANS
6-27-03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Harry Hedler et al.
Applic. No. : 10/056,356
Filed : January 24, 2002
Title : Electronic Component with a Semiconductor
Chip and Method of Producing the Electronic
Component
Examiner : Hung V. Ngo
Group Art Unit : 2831

A M E N D M E N T

Hon. Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

S i r :

Responsive to the Office action dated March 12, 2003 kindly
amend the above-identified application as follows:

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